
HM514400D Series

4M FP DRAM (1-Mword $\times$ 4-bit)
1k refresh

HITACHI

ADE-203-679A (Z)

Rev. 1.0

Nov. 13, 1997

Description

The Hitachi HM514400D is a CMOS dynamic RAM organized 1,048,576-word $\times$ 4-bit. HM514400D has realized higher density, higher performance and various functions by employing 0.8 μ m CMOS process technology and some new CMOS circuit design technologies. The HM514400D offers Fast Page Mode as a high speed access mode. Multiplexed address input permits the HM514400D to be packaged in standard 300-mil 26-pin plastic SOJ.

Features

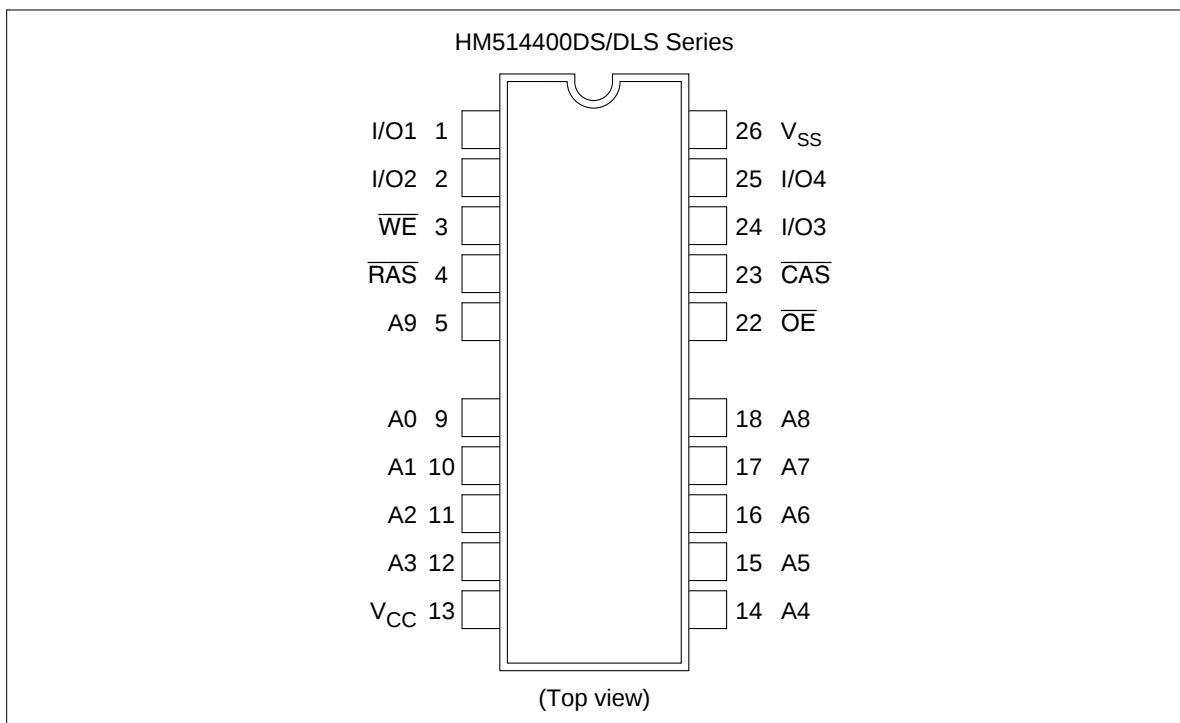
- Single 5 V ($\pm 10\%$)
- Access time: 60 ns/70 ns/80 ns (max)
- Power dissipation
 - Active mode: 605 mW/550 mW/495 mW (max)
 - Standby mode: 11 mW (max)
0.55 mW (max) (L-version)
- Fast page mode capability
- Refresh cycles
 - 1024 refresh cycles: 16 ms
: 128 ms (L-version)
- 3 variations of refresh
 - $\overline{\text{RAS}}$ -only refresh
 - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
- Test function
- Battery backup operation (L-version)

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Ordering Information

Type No.	Access time	Package
HM514400DS-6	60 ns	300-mil 26-pin plastic SOJ (CP-26/20D)
HM514400DS-7	70 ns	
HM514400DS-8	80 ns	
HM514400DLS-6	60 ns	
HM514400DLS-7	70 ns	
HM514400DLS-8	80 ns	

Pin Arrangement

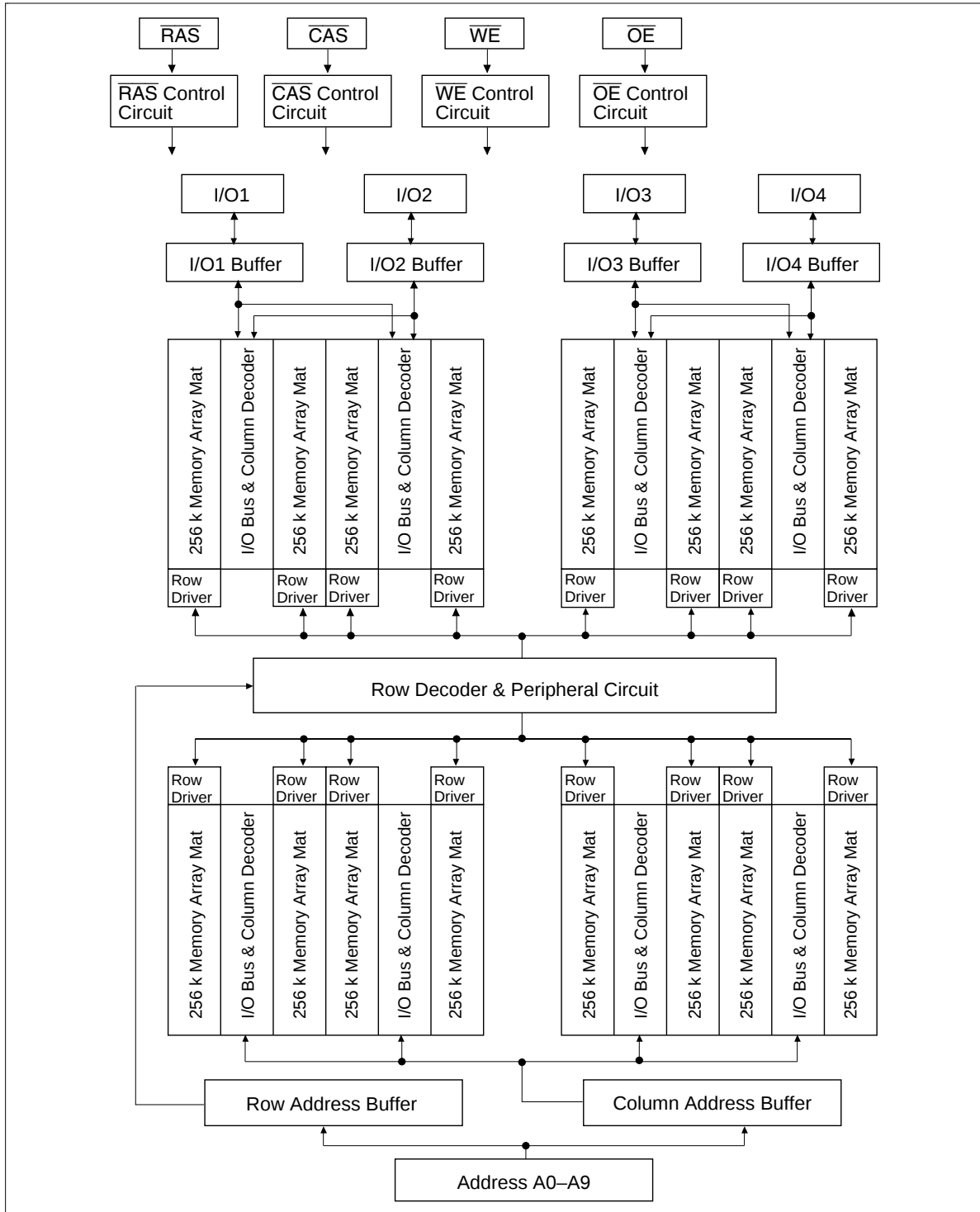


Pin Description

Pin name	Function
A0 to A9	Address input • Row address A0 to A9 • Column address A0 to A9 • Refresh address A0 to A9
I/O1 to I/O4	Data-in/Data-out
$\overline{\text{RAS}}$	Row address strobe
$\overline{\text{CAS}}$	Column address strobe
$\overline{\text{WE}}$	Read/Write enable
$\overline{\text{OE}}$	Output enable
V_{CC}	Power supply
V_{SS}	Ground

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Block Diagram



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Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	-1.0 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-55 to +125	°C

Recommended DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{SS}	0	0	0	V	
	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	-1.0	—	0.8	V	1

Note: 1. All voltage referred to V_{SS} .

DC Characteristics ($T_a = 0$ to +70°C, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$)

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Parameter	Symbol							Unit	Test conditions
		-6		-7		-8			
		Min	Ma	Min	Ma	Min	Ma		
		x		x		x			

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HM514400D									
Parameter	Symbol							Unit	Test conditions
		-6		-7		-8			
		Min	Ma	Min	Ma	Min	Ma		
		x		x		x			
Operating current ^{*1, *2}	I _{CC1}	—	110	—	100	—	90	mA	$\overline{\text{RAS}}$, $\overline{\text{CAS}}$ cycling t _{RC} = min
Standby current	I _{CC2}	—	2	—	2	—	2	mA	TTL interface $\overline{\text{RAS}}$, $\overline{\text{CAS}}$ = V _{IH} Dout = High-Z
		—	1	—	1	—	1	mA	CMOS interface $\overline{\text{RAS}}$, $\overline{\text{CAS}}$ ≥ V _{CC} – 0.2 V Dout = High-Z
Standby current (L-version) ^{*4}	I _{CC2}	—	100	—	100	—	100	μA	CMOS interface $\overline{\text{RAS}}$, $\overline{\text{CAS}}$ = V _{IH} $\overline{\text{WE}}$, $\overline{\text{OE}}$, Address and Din = V _{IH} or V _{IL} Dout = High-Z
$\overline{\text{RAS}}$ -only refresh current ^{*2}	I _{CC3}	—	110	—	100	—	90	mA	t _{RC} = min
Standby current ^{*1}	I _{CC5}	—	5	—	5	—	5	mA	$\overline{\text{RAS}}$ = V _{IH} , $\overline{\text{CAS}}$ = V _{IL} Dout = enable
$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh current	I _{CC6}	—	110	—	100	—	90	mA	t _{RC} = min
Fast page mode current ^{*1, *3}	I _{CC7}	—	110	—	100	—	90	mA	t _{PC} = min
Battery backup current ^{*4} (Standby with CBR refresh) (L-version)	I _{CC10}	—	200	—	200	—	200	μA	t _{RC} = 125 μs t _{RAS} ≤ 1 μs $\overline{\text{WE}}$ = V _{IH} , $\overline{\text{CAS}}$ = V _{IL} $\overline{\text{OE}}$, Address and Din = V _{IH} or V _{IL} Dout = High-Z
Input leakage current	I _{LI}	–10	10	–10	10	–10	10	μA	0 V ≤ Vin ≤ 7 V
Output leakage current	I _{LO}	–10	10	–10	10	–10	10	μA	0 V ≤ Vout ≤ 7 V Dout = disable
Output high voltage	V _{OH}	2.4	V _{CC}	2.4	V _{CC}	2.4	V _{CC}	V	High Iout = –5 mA
Output low voltage	V _{OL}	0	0.4	0	0.4	0	0.4	V	Low Iout = 4.2 mA

- Notes: 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.
2. Address can be changed twice or less while $\overline{\text{RAS}}$ = V_{IL}.
3. Address can be changed once or less while $\overline{\text{CAS}}$ = V_{IH}.
4. V_{CC} – 0.2 V ≤ V_{IH} ≤ 6.5 V and 0 V ≤ V_{IL} ≤ 0.2 V.

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Capacitance ($T_a = 25^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C_{I1}	—	5	pF	1
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	$C_{I/O}$	—	7	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{CAS} = V_{IH}$ to disable Dout.

AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$)^{*1, *14, *15, *16}**Test Conditions**

- Input rise and fall time : 5 ns
- Input timing reference levels : 0.8 V, 2.4 V
- Output load : 2 TTL gate + C_L (100 pF) (Including scope and jig)

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Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Random read or write cycle time	t_{RC}	110	—	130	—	150	—	ns	
$\overline{RAS}$ precharge time	t_{RP}	40	—	50	—	60	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	60	10000	70	10000	80	10000	ns	19
$\overline{CAS}$ pulse width	t_{CAS}	15	10000	20	10000	20	10000	ns	20
Row address setup time	t_{ASR}	0	—	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	0	—	ns	
Column address hold time	t_{CAH}	15	—	15	—	15	—	ns	
$\overline{RAS}$ to $\overline{CAS}$ delay time	t_{RCD}	20	45	20	50	20	60	ns	8
$\overline{RAS}$ to column address delay time	t_{RAD}	15	30	15	35	15	40	ns	9
$\overline{RAS}$ hold time	t_{RSH}	15	—	20	—	20	—	ns	
$\overline{CAS}$ hold time	t_{CSH}	60	—	70	—	80	—	ns	
$\overline{CAS}$ to $\overline{RAS}$ precharge time	t_{CRP}	10	—	10	—	10	—	ns	
$\overline{OE}$ to Din delay time	t_{ODD}	15	—	20	—	20	—	ns	
$\overline{OE}$ delay time from Din	t_{DZO}	0	—	0	—	0	—	ns	
$\overline{CAS}$ setup time from Din	t_{DZC}	0	—	0	—	0	—	ns	
Transition time (rise and fall)	t_T	3	50	3	50	3	50	ns	7
Refresh period	t_{REF}	—	16	—	16	—	16	ms	
Refresh period (L-version)	t_{REF}	—	128	—	128	—	128	ms	

HM514400D Series

Read Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	—	80	ns	2, 3, 17
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	20	—	20	ns	3, 4, 13, 17
Access time from address	t_{AA}	—	30	—	35	—	40	ns	3, 5, 13, 17
Access time from $\overline{\text{OE}}$	t_{OAC}	—	15	—	20	—	20	ns	3, 17
Read command setup time	t_{RCS}	0	—	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	0	—	ns	18
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	0	—	ns	18
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	40	—	ns	
Output buffer turn-off time	t_{OFF1}	0	15	0	20	0	20	ns	6
Output buffer turn-off time to $\overline{\text{OE}}$	t_{OFF2}	0	15	0	20	0	20	ns	6
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	20	—	20	—	ns	
$\overline{\text{OE}}$ pulse width	t_{OEP}	15	—	20	—	20	—	ns	

Write Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Write command setup time	t _{WCS}	0	—	0	—	0	—	ns	10
Write command hold time	t _{WCH}	15	—	15	—	15	—	ns	
Write command pulse width	t _{WP}	10	—	10	—	10	—	ns	
Write command to $\overline{\text{RAS}}$ lead time	t _{RWL}	15	—	20	—	20	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	t _{CWL}	15	—	20	—	20	—	ns	
Data-in setup time	t _{DS}	0	—	0	—	0	—	ns	11
Data-in hold time	t _{DH}	15	—	15	—	15	—	ns	11

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Read-Modify-Write Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Read-modify-write cycle time	t_{RWC}	150	—	180	—	200	—	ns	
$\overline{RAS}$ to $\overline{WE}$ delay time	t_{RWD}	80	—	95	—	105	—	ns	10
$\overline{CAS}$ to $\overline{WE}$ delay time	t_{CWD}	35	—	45	—	45	—	ns	10
Column address to $\overline{WE}$ delay time	t_{AWD}	50	—	60	—	65	—	ns	10
$\overline{OE}$ hold time from $\overline{WE}$	t_{OEH}	15	—	20	—	20	—	ns	

Refresh Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
$\overline{CAS}$ setup time (CBR refresh cycle)	t_{CSR}	10	—	10	—	10	—	ns	
$\overline{CAS}$ hold time (CBR refresh cycle)	t_{CHR}	10	—	10	—	10	—	ns	
$\overline{RAS}$ precharge to $\overline{CAS}$ hold time	t_{RPC}	10	—	10	—	10	—	ns	
$\overline{CAS}$ precharge time in normal mode	t_{CPN}	10	—	10	—	10	—	ns	

Fast Page Mode Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Fast page mode cycle time	t_{PC}	40	—	45	—	50	—	ns	
Fast page mode $\overline{CAS}$ precharge time	t_{CP}	10	—	10	—	10	—	ns	
Fast page mode $\overline{RAS}$ pulse width	t_{RASC}	—	100000	—	100000	—	100000	ns	12
Access time from $\overline{CAS}$ precharge	t_{ACP}	—	35	—	40	—	45	ns	3, 13, 17
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	t_{RHCP}	35	—	40	—	45	—	ns	

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Fast Page Mode Read-Modify-Write Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes
Fast page mode read-modify-write cycle time	t_{PCM}	80	—	95	—	100	—	ns	
Fast page mode read-modify-write cycle CAS precharge to $\overline{WE}$ delay time	t_{CPW}	55	—	65	—	70	—	ns	10

Test Mode Cycle

		HM514400D							
		-6		-7		-8			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit	Notes

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Test mode $\overline{WE}$ setup time	t_{WS}	0	—	0	—	0	—	ns
Test mode $\overline{WE}$ hold time	t_{WH}	10	—	10	—	10	—	ns

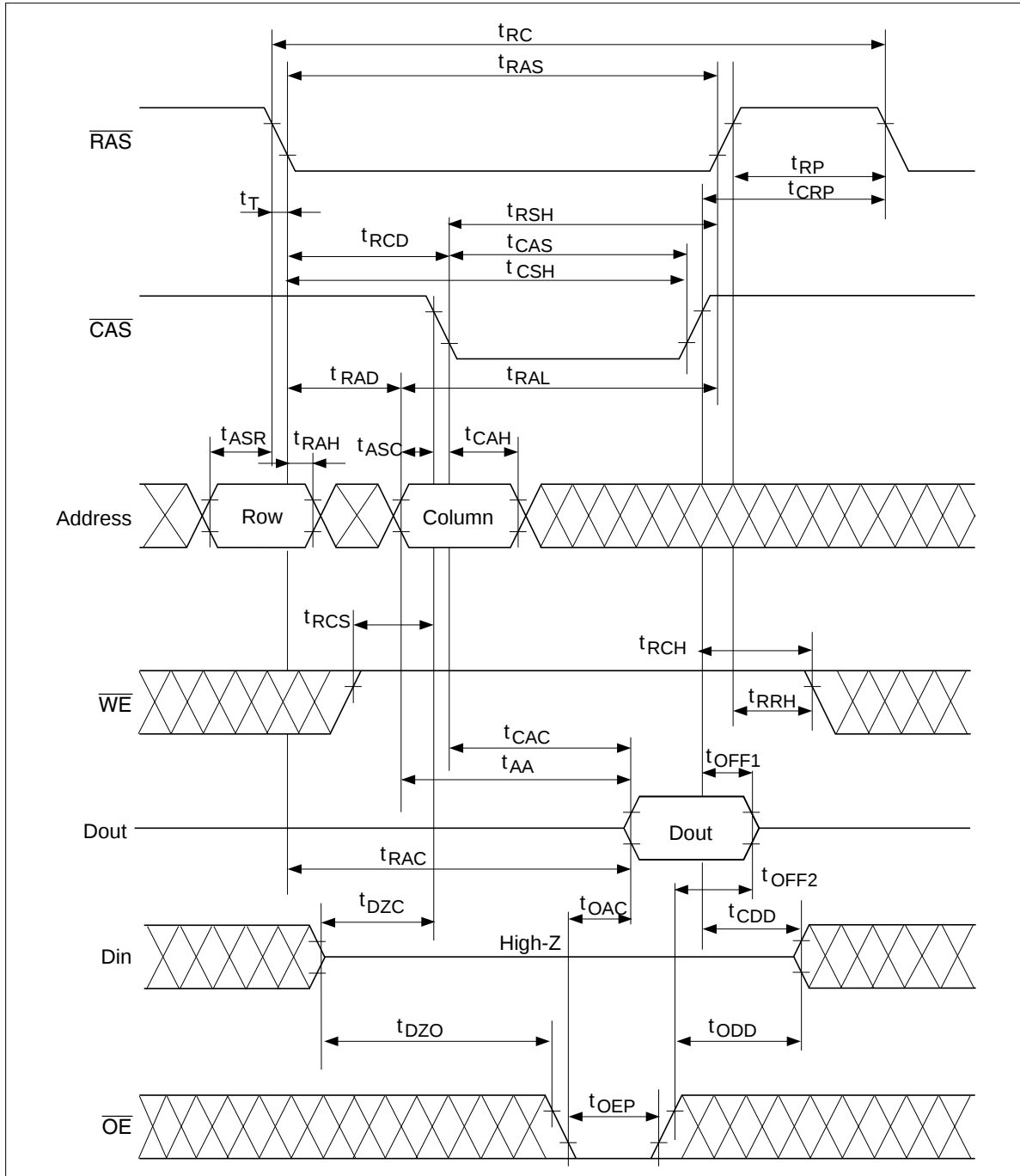
- Notes:
1. AC measurements assume $t_r = 5$ ns.
 2. Assumes that $t_{RCD} \leq t_{RCD}(\text{max})$ and $t_{RAD} \leq t_{RAD}(\text{max})$. If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 3. Measured with a load circuit equivalent to 2 TTL loads and 100 pF.
 4. Assumes that $t_{RCD} \geq t_{RCD}(\text{max})$ and $t_{RAD} \leq t_{RAD}(\text{max})$.
 5. Assumes that $t_{RCD} \leq t_{RCD}(\text{max})$ and $t_{RAD} \geq t_{RAD}(\text{max})$.
 6. $t_{OFF}(\text{max})$ defines the time at which the output achieves the open circuit condition and is not referred to output voltage levels.
 7. $V_{IH}(\text{min})$ and $V_{IL}(\text{max})$ are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL} .
 8. Operation with the $t_{RCD}(\text{max})$ limit insures that $t_{RAC}(\text{max})$ can be met, $t_{RCD}(\text{max})$ is specified as a reference point only, if t_{RCD} is greater than the specified $t_{RCD}(\text{max})$ limit, then access time is controlled exclusively by t_{CAC} .
 9. Operation with the $t_{RAD}(\text{max})$ limit insures that $t_{RAC}(\text{max})$ can be met, $t_{RAD}(\text{max})$ is specified as a reference point only, if t_{RAD} is greater than the specified $t_{RAD}(\text{max})$ limit, then access time is controlled exclusively by t_{AA} .
 10. t_{WCS} , t_{RWD} , t_{CWD} , t_{CPW} and t_{AWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{WCS} \geq t_{WCS}(\text{min})$, the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{RWD} \geq t_{RWD}(\text{min})$, $t_{CWD} \geq t_{CWD}(\text{min})$, $t_{CPW} \geq t_{CPW}(\text{min})$ and $t_{AWD} \geq t_{AWD}(\text{min})$, the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 11. These parameters are referred to $\overline{CAS}$ leading edge in an early write cycle and to $\overline{WE}$ leading edge in a delayed write or read-modify-write cycle.
 12. t_{RASC} defines $\overline{RAS}$ pulse width in fast page mode cycles.
 13. Access time is determined by the longest among t_{AA} , t_{CAC} and t_{ACP} .
 14. An initial pause of 100 μs is required after power up followed by a minimum of eight initialization cycles ($\overline{RAS}$ -only refresh cycle or $\overline{CAS}$ -before- $\overline{RAS}$ refresh cycle). If the internal refresh counter is used, a minimum of eight $\overline{CAS}$ -before- $\overline{RAS}$ refresh cycles is required.
 15. In delayed write or read-modify-write cycles, $\overline{OE}$ must disable output buffer prior to applying data to the device.

16. Test mode operation specified in this data sheet is 2-bit test function controlled by control address bits - - CA0. This test mode operation can be performed by $\overline{WE}$ -and- $\overline{CAS}$ -before- $\overline{RAS}$ (WCBR) refresh cycle. Refresh during test mode operation will be performed by normal read cycles or by WCBR refresh cycles. When the state of two test bits accord each other, the condition of the output data is high level. When the state of test bits do not accord, the condition of the output data is low level. In order to end this test mode operation, perform a $\overline{RAS}$ -only refresh cycle or a $\overline{CAS}$ -before- $\overline{RAS}$ refresh cycle.
17. In a test mode read cycle, the value of t_{RAC} , t_{AA} , t_{CAC} , t_{OAC} and t_{ACP} is delayed for 2 ns to 5ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.
18. Either t_{RCH} or t_{RRH} must be satisfied
19. $t_{RAS} \text{ (min)} = t_{RWD} \text{ (min)} + t_{RWL} \text{ (min)} + t_T$ in read-modify-write cycle.
20. $t_{CAS} \text{ (min)} = t_{CWD} \text{ (min)} + t_{CWL} \text{ (min)} + t_T$ in read-modify-write cycle.
21. XXX: H or L (H: $V_{IH} \text{ (min)} \leq V_{IN} \leq V_{IH} \text{ (max)}$, L: $V_{IL} \text{ (min)} \leq V_{IN} \leq V_{IL} \text{ (max)}$)
 //////////////: Invalid Dout
 When the address, clock and input pins are not described on timing waveforms, their pins must be applied V_{IH} or V_{IL} .

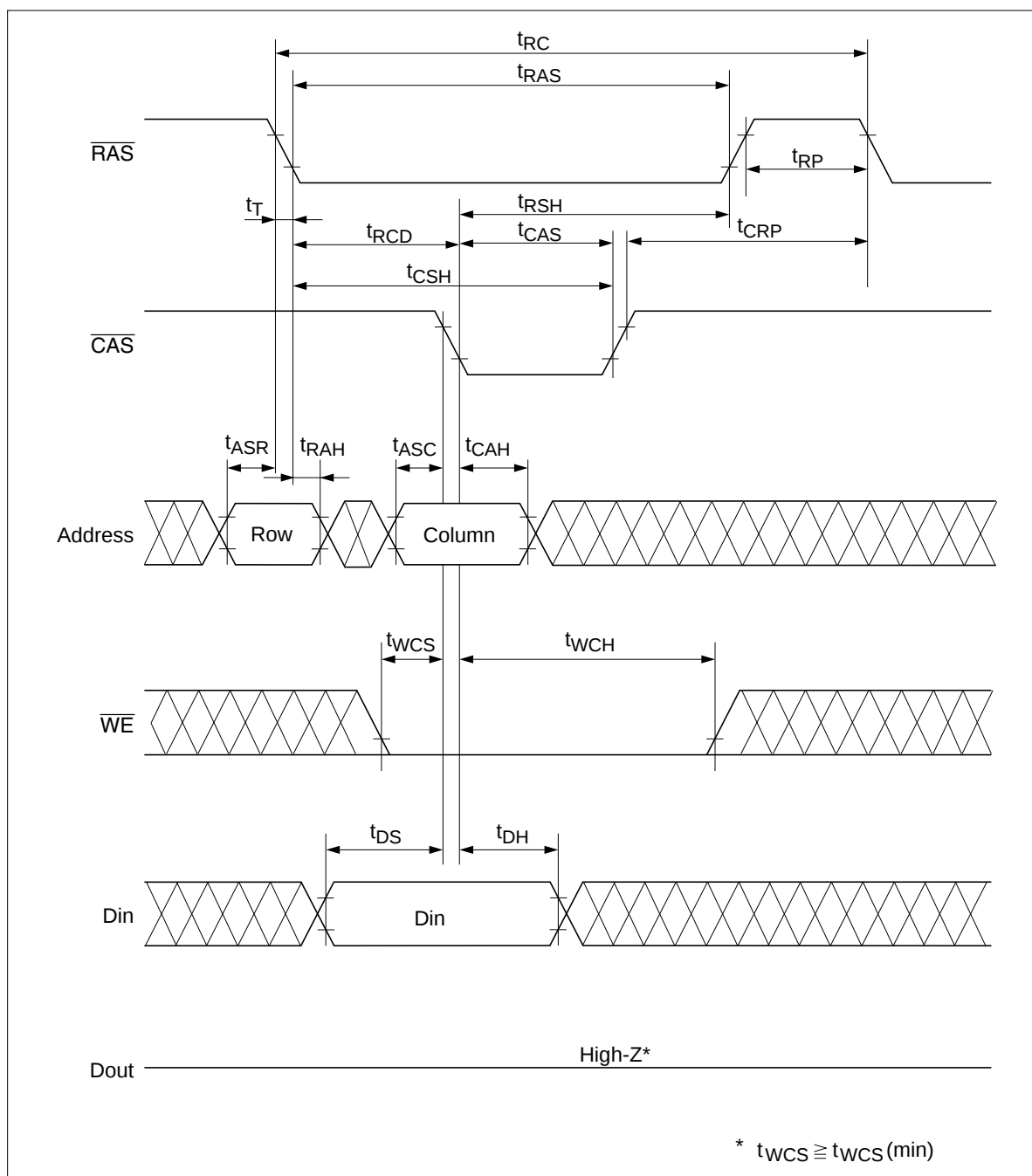
HM514400D Series

Timing Waveforms^{*21}

Read Cycle

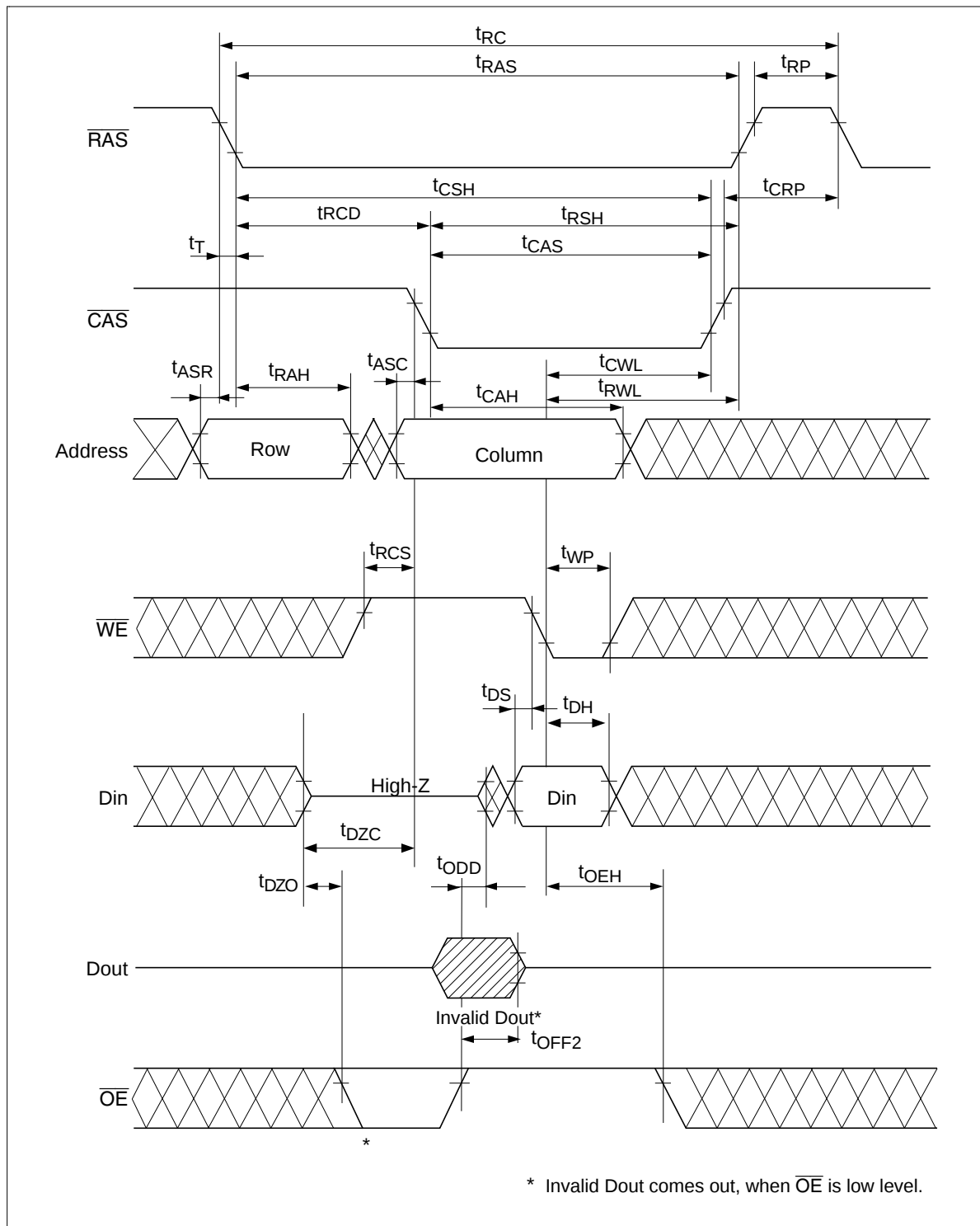


Early Write Cycle

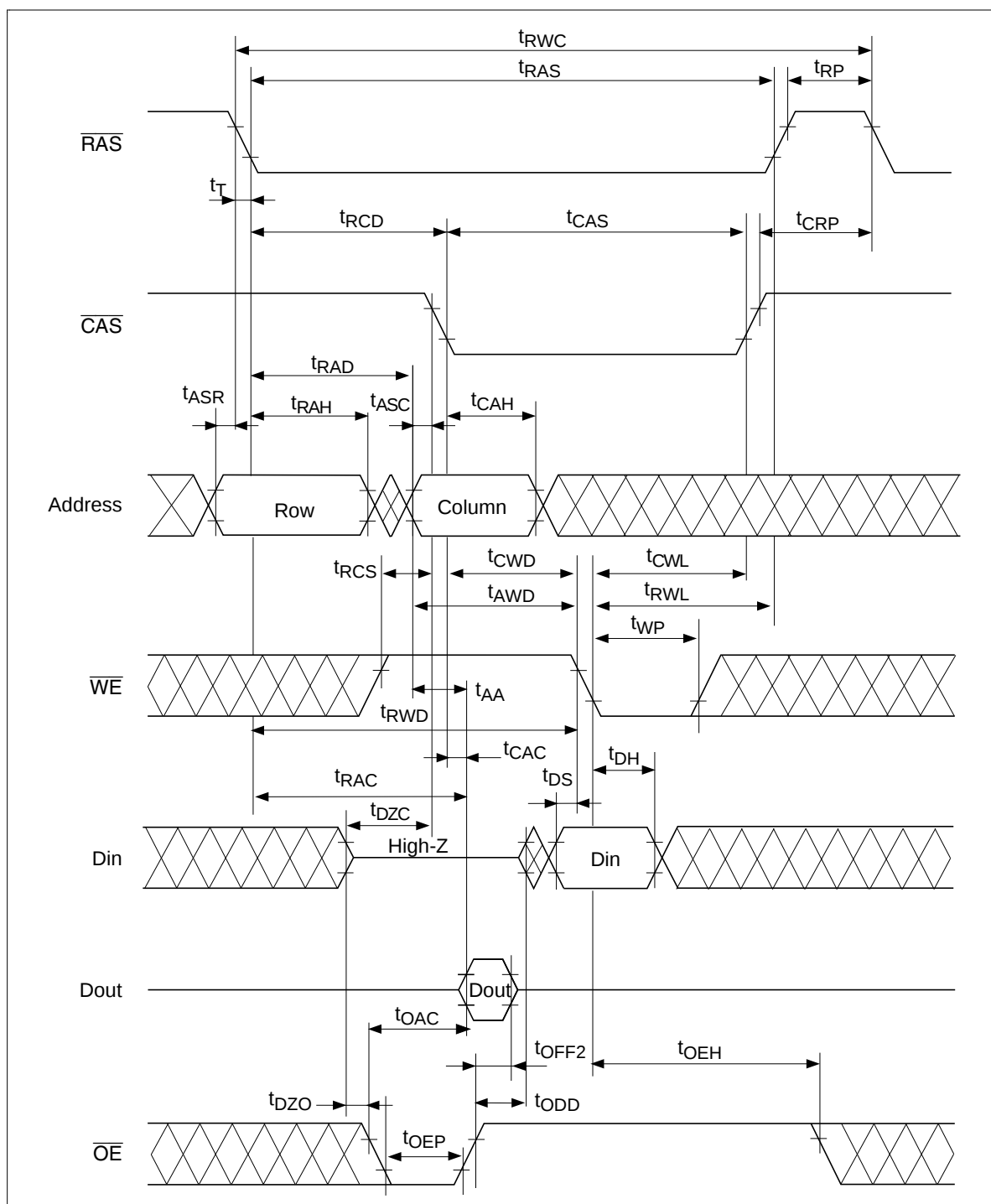


HM514400D Series

Delayed Write Cycle *15

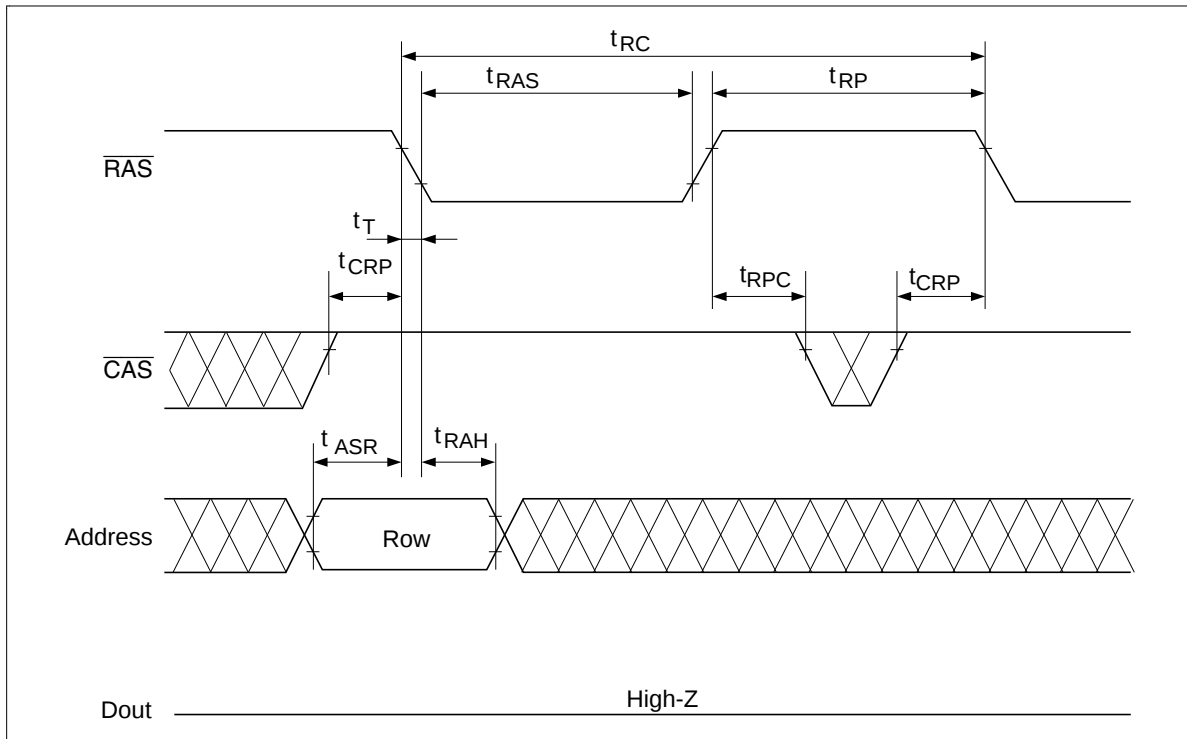


Read-Modify-Write Cycle *¹⁵

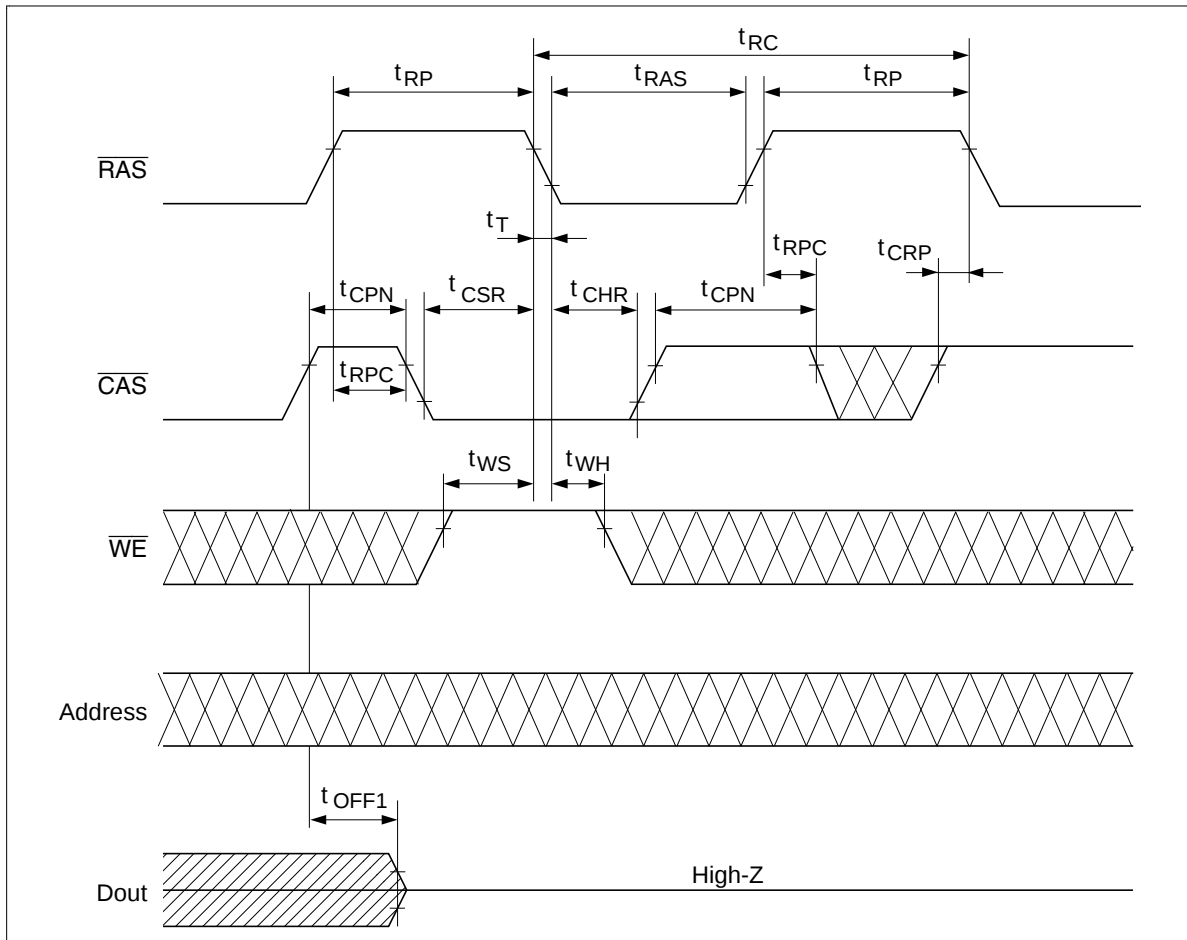


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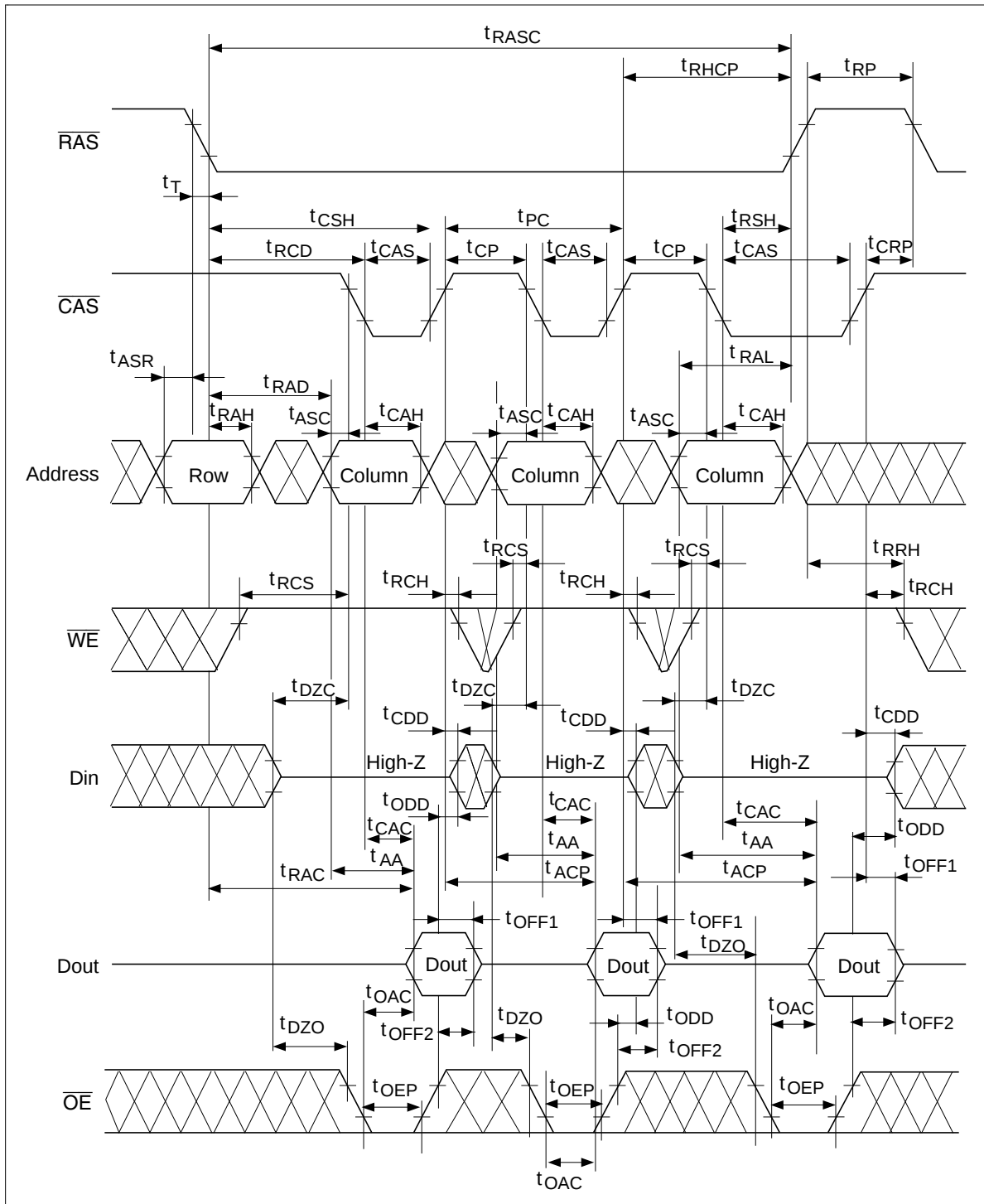
$\overline{\text{RAS}}$ -Only Refresh Cycle



$\overline{\text{CAS}}$ -Before- $\overline{\text{RAS}}$ Refresh Cycle

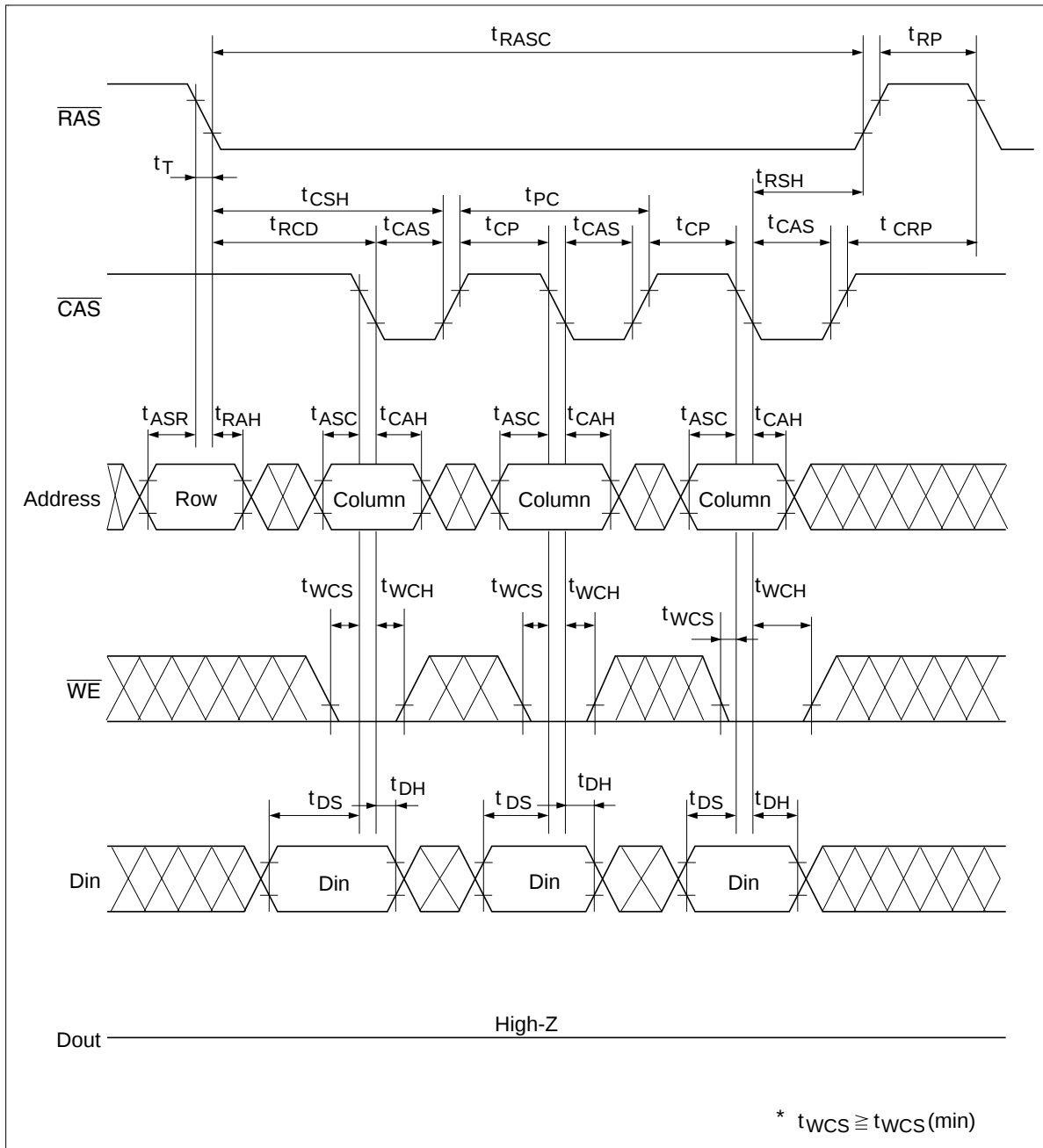


Fast Page Mode Read Cycle

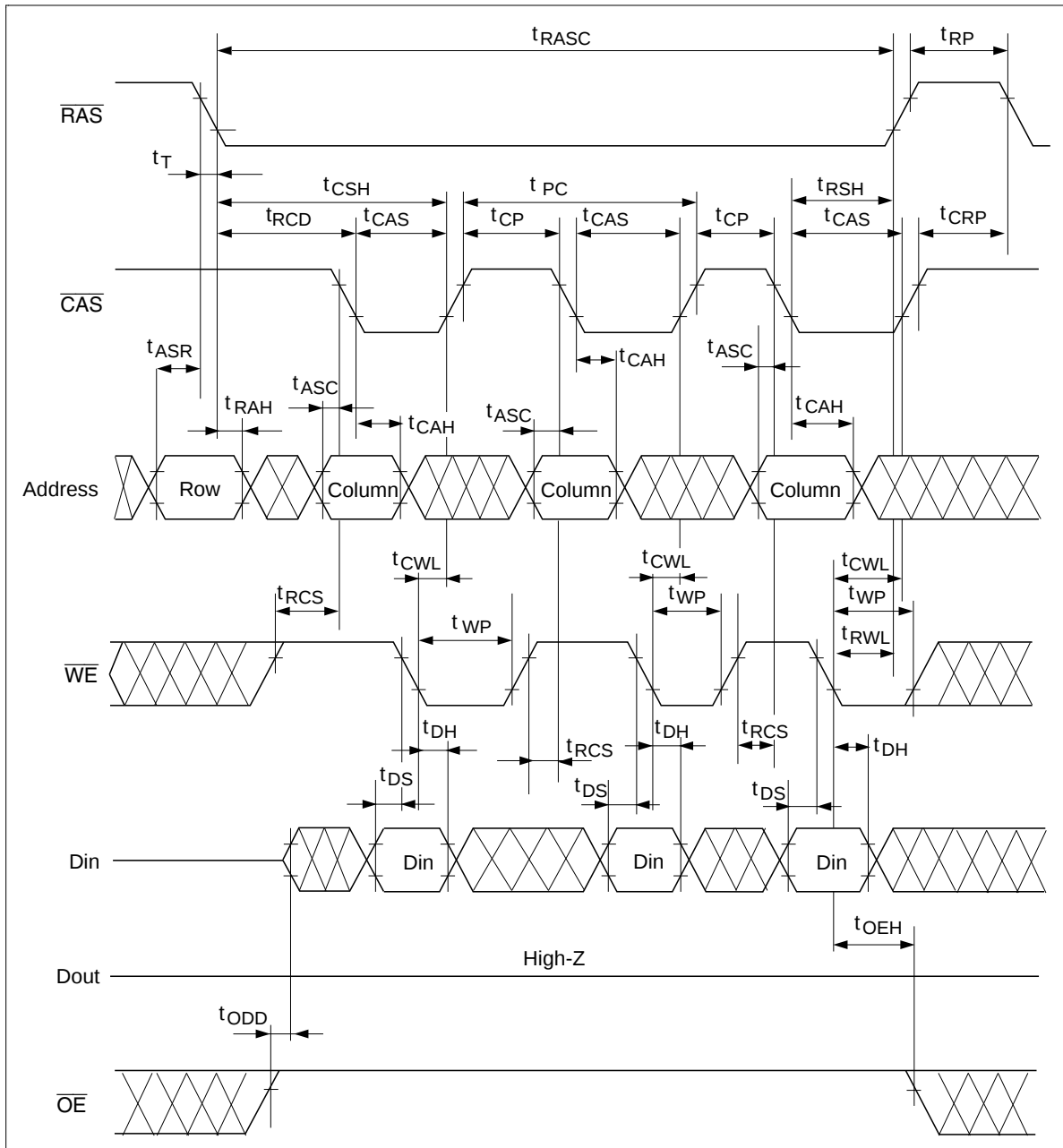


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Fast Page Mode Early Write Cycle

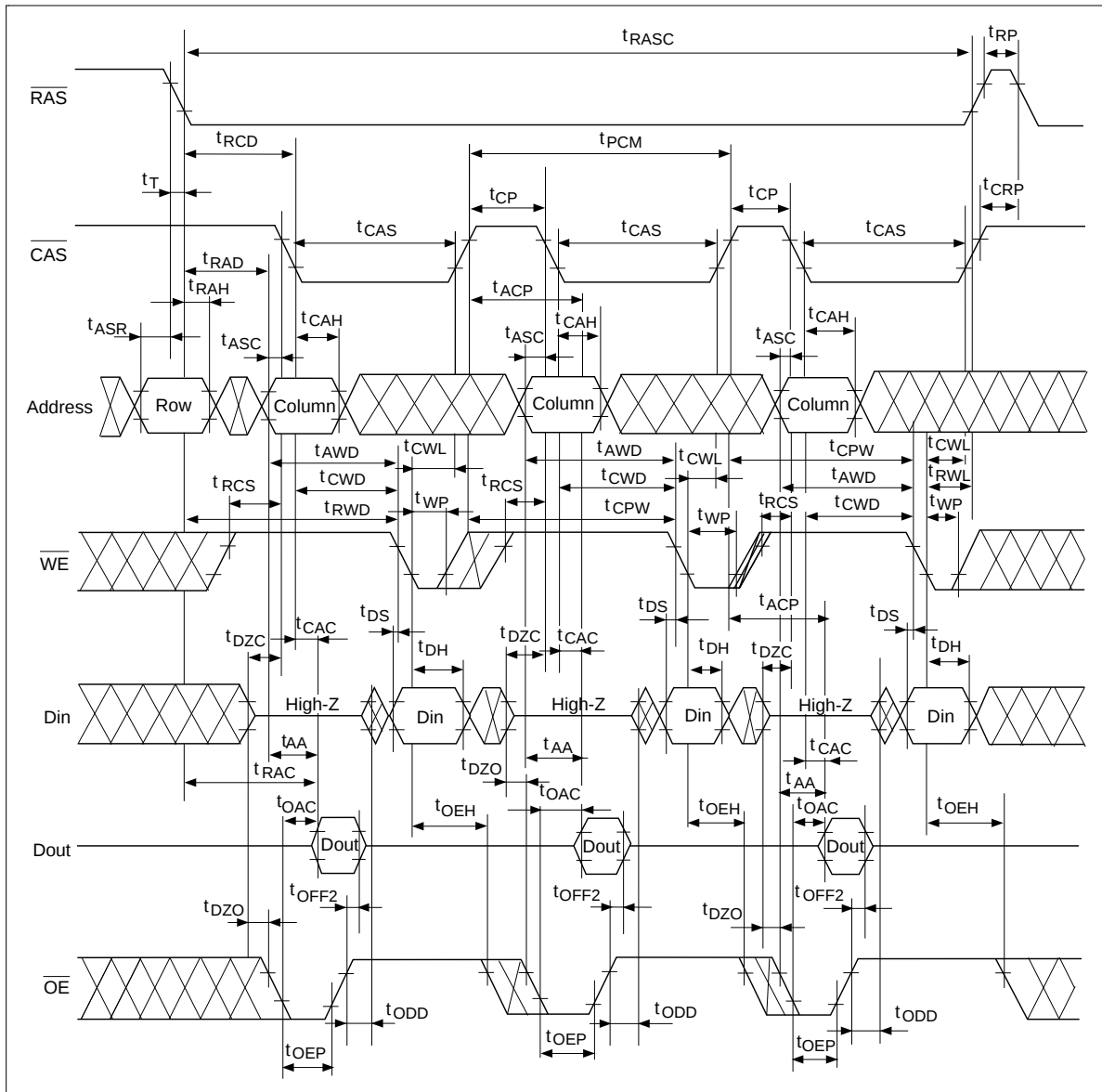


Fast Page Mode Delayed Write Cycle ^{*15}

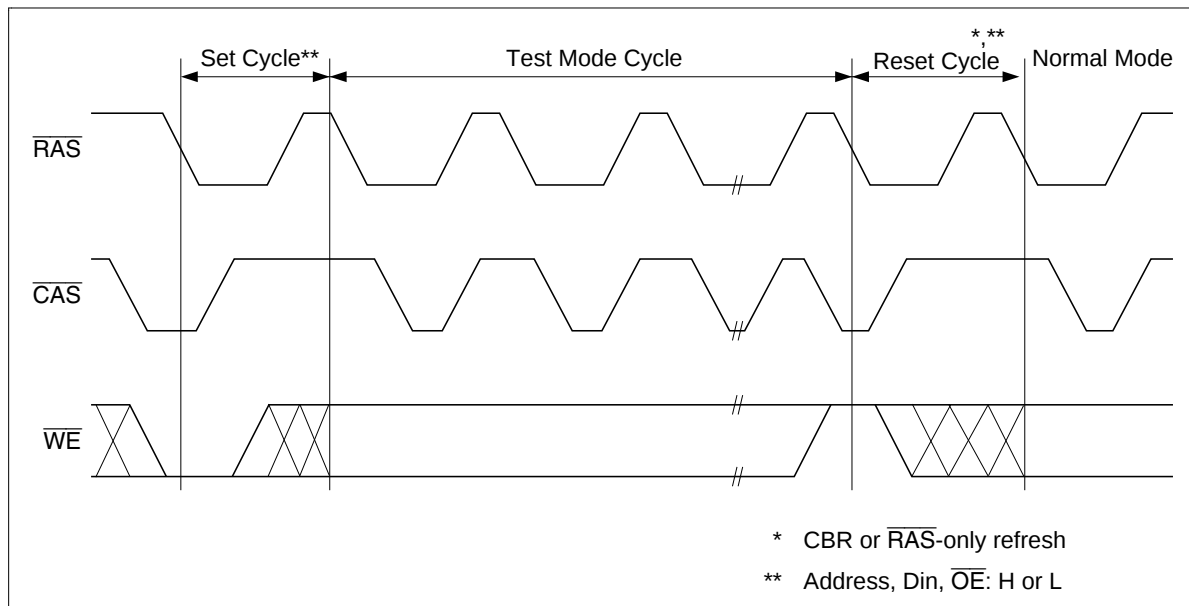


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Fast Page Mode Read-Modify-Write Cycle *¹⁵



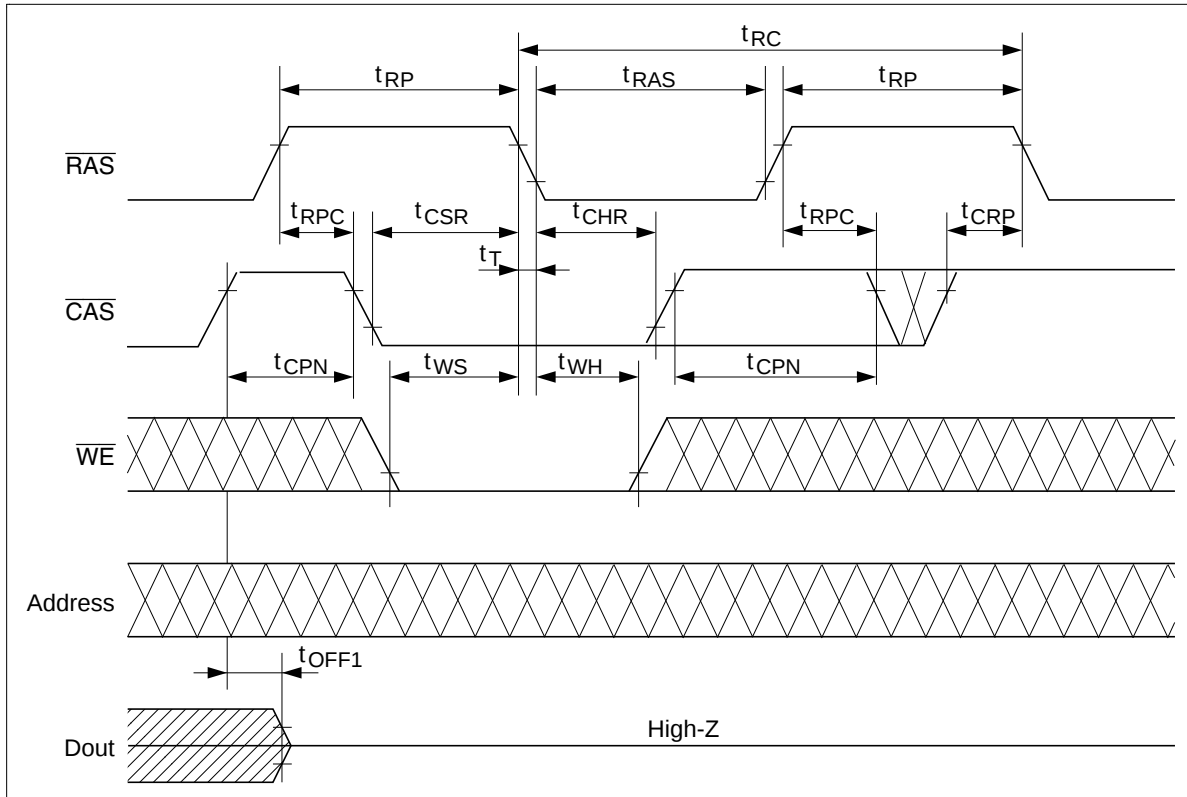
Test Mode Cycle



HM514400D Series

Test Mode Set Cycle

$\overline{\text{WE}}$ -and- $\overline{\text{CAS}}$ -Before $\overline{\text{RAS}}$ -Refresh Cycle



HM514400D Series

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HM514400D Series

Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Nov. 27, 1996	Initial issue	T. Oono	S.Suzuki
1.0	Nov. 13, 1997	Deletion of HM514400DTT Series		